

### **Description**

The SVD5867NLT4G uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

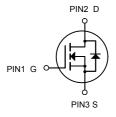


## TO-252-2L (DPAK)

#### **General Features**

 $V_{DS} = 60V I_{D} = 20 A$ 

 $R_{DS(ON)}$  < 32m $\Omega$  @  $V_{GS}$ =10V



#### N-Channel MOSFET

## **Application**

**Battery protection** 

Load switch

Uninterruptible power supply

## **Package Marking and Ordering Information**

| Product ID   | Pack            | Brand      | Qty(PCS) |
|--------------|-----------------|------------|----------|
| SVD5867NLT4G | TO-252-2L(DPAK) | HXY MOSFET | 2500     |

## Absolute Maximum Ratings (T<sub>c</sub>=25°C unless otherwise noted)

| Symbol                                | Parameter  | Rating                  | Units |
|---------------------------------------|--|-------------------------|-------|
| Vos                                   | Drain-Source Voltage   | Drain-Source Voltage 60 |       |
| Vgs                                   | Gate-Source Voltage  | ±20                     | V     |
| I <sub>D</sub> @T <sub>C</sub> =25°C  | Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup> | 20                      | А     |
| I <sub>D</sub> @T <sub>C</sub> =100°C | Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup> | 10                      | Α     |
| Ідм                                   | Pulsed Drain Current <sup>2</sup>                            | 80                      | А     |
| EAS                                   | Single Pulse Avalanche Energy <sup>3</sup>                   | 38                      | mJ    |
| P <sub>D</sub> @T <sub>C</sub> =25°C  | Total Power Dissipation⁴                                     | 34.7                    | W     |
| Тѕтс                                  | Storage Temperature Range                                    | -55 to 150              | °C    |
| TJ                                    | Operating Junction Temperature Range -55 to 150              |                         | °C    |



# Electrical Characteristics (T<sub>J</sub> = 25°C, unless otherwise noted)

| Parameter                             |                       | Symbol               | Test Conditions  | Min.     | Тур. | Max. | Unit |  |
|---------------------------------------|-----------------------|----------------------|--|----------|------|------|------|--|
| Static Characteristics                |                       |                      |  | <b>.</b> | •    |      |      |  |
| Drain-Source Breakdown Voltage        |                       | V <sub>(BR)DSS</sub> | V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA               | 60       | -    | -    | V    |  |
| Gate-Body Leakage Current             |                       | Igss                 | V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±20V               | -        | -    | ±100 | nA   |  |
| Zero Gate Voltage Drain<br>Current    | T <sub>J</sub> =25°C  |                      | V 00V V 0V   | -        | -    | 1    | μА   |  |
|                                       | T <sub>J</sub> =100°C | IDSS                 | V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V                | -        | -    | 100  |      |  |
| Gate-Threshold Voltage                |                       | V <sub>GS(th)</sub>  | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA | 1.2      | 1.7  | 2.5  | V    |  |
| Dania Course on Desistence            |                       |                      | V <sub>GS</sub> = 10V, I <sub>D</sub> = 10A                | -        | 25   | 32   |      |  |
| Drain-Source on-Resistance            | 2*                    | R <sub>DS(on)</sub>  | V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 5A                | -        | 31.5 | 40   | mΩ   |  |
| Forward Transconductance <sup>4</sup> |                       | <b>g</b> fs          | V <sub>DS</sub> = 5V, I <sub>D</sub> = 10A                 | -        | 15.5 | -    | S    |  |
| Dynamic Characteristic                | <b>s</b> <sup>5</sup> |                      |  | •        |      | •    |      |  |
| Input Capacitance                     |                       | C <sub>iss</sub>     |  | -        | 1355 | -    |      |  |
| Output Capacitance                    |                       | Coss                 | $V_{DS}$ = 30V, $V_{GS}$ =0V, $f$ =1MHz                    | -        | 60   | -    | pF   |  |
| Reverse Transfer Capacitance          |                       | Crss                 |  | -        | 49   | -    |      |  |
| Gate Resistance                       |                       | Rg                   | f=1MHz   | -        | 1.2  | -    | Ω    |  |
| Switching Characteristi               | CS <sup>5</sup>       |                      |  |          |      |      |      |  |
| Total Gate Charge                     |                       | Qg                   |  | -        | 22   | -    |      |  |
| Gate-Source Charge                    |                       | Q <sub>gs</sub>      | $V_{GS} = 10V, V_{DD} = 30V,$ $I_{D} = 10A$                | -        | 4.2  | -    | nC   |  |
| Gate-Drain Charge                     |                       | $Q_{gd}$             |  | -        | 6.9  | -    |      |  |
| Turn-on Delay Time                    |                       | t <sub>d(on)</sub>   |  | -        | 6.4  | -    |      |  |
| Rise Time                             |                       | t <sub>r</sub>       | $V_{GS} = 10V, V_{DD} = 30V,$                              | -        | 15.3 | -    | ne   |  |
| Turn-off Delay Time                   |                       | t <sub>d(off)</sub>  | $R_G = 3\Omega$ , $I_D = 10A$                              | -        | 25   | -    | . ns |  |
| Fall Time                             |                       | t <sub>f</sub>       |  | -        | 7.6  | -    |      |  |
| Body Diode Reverse Recovery Time      |                       | trr                  |  | -        | 26   | -    | ns   |  |
| Body Diode Reverse Recovery Charge    |                       | Qrr                  | - I <sub>F</sub> =10A, dI <sub>F</sub> /dt=100A/μs         | -        | 45   | -    | nC   |  |
| Drain-Source Body Dioc                | de Charactei          | ristics              |  | <u>'</u> |      | •    |      |  |
| Diode Forward Voltage <sup>4</sup>    |                       | V <sub>SD</sub>      | I <sub>S</sub> = 10A, V <sub>GS</sub> = 0V                 | -        | -    | 1.2  | V    |  |
| Continuous Source Current             | T <sub>C</sub> =25℃   | Is                   | -  | -        | -    | 20   | Α    |  |

#### Notes:

- 1. Repetitive rating, pulse width limited by junction temperature  $T_{J(MAX)}$ =150 $^{\circ}$ C
- 2. The EAS data shows Max. rating . The test condition is  $V_{\text{DD}}$ =25V,  $V_{\text{GS}}$ =10V, L=0.4mH,  $I_{\text{AS}}$ =14A
- 3. The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper, The value in any given application depends on the user's specific board design.
- 4. The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%.
- 5. This value is guaranteed by design hence it is not included in the production test.



# **Typical Characteristics**

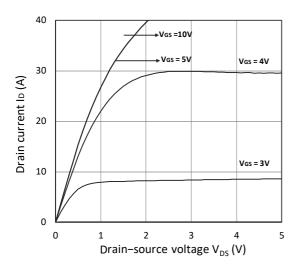


Figure 1. Output Characteristics

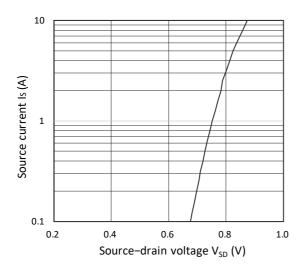


Figure 3. Forward Characteristics of Reverse

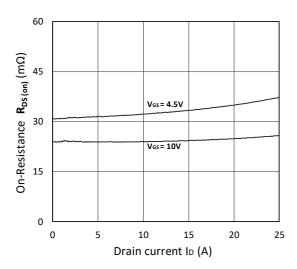


Figure 5.  $R_{DS(ON)}$  vs.  $I_D$ 

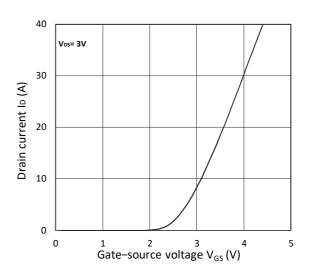


Figure 2. Transfer Characteristics

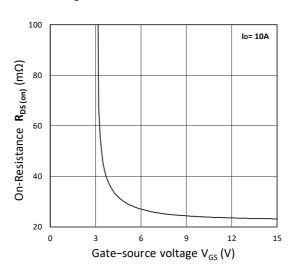


Figure 4.  $R_{DS(ON)}$  vs.  $V_{GS}$ 

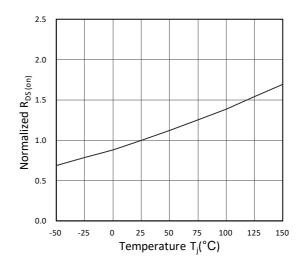
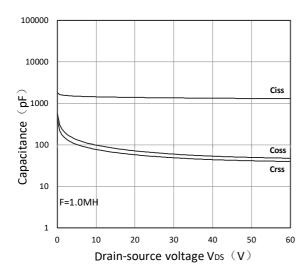
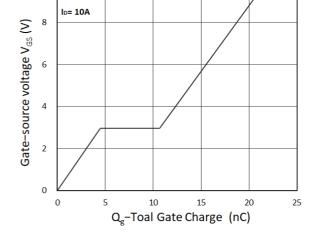


Figure 6. Normalized  $R_{DS(on)}$  vs. Temperature

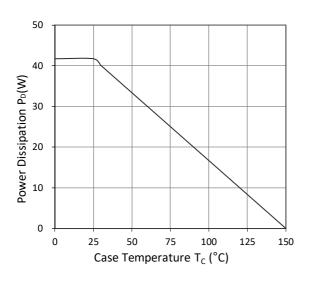




**V**<sub>DS</sub> = **30V** 

Figure 7. Capacitance Characteristics

Figure 8. Gate Charge Characteristics



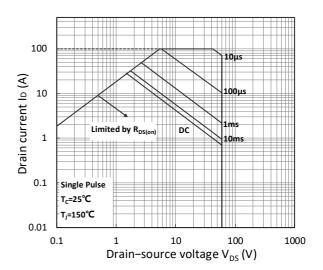


Figure 9. Power Dissipation

Figure 10. Safe Operating Area

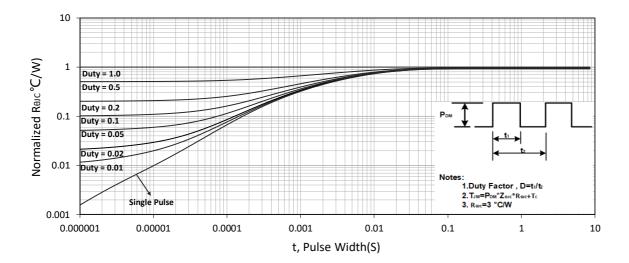
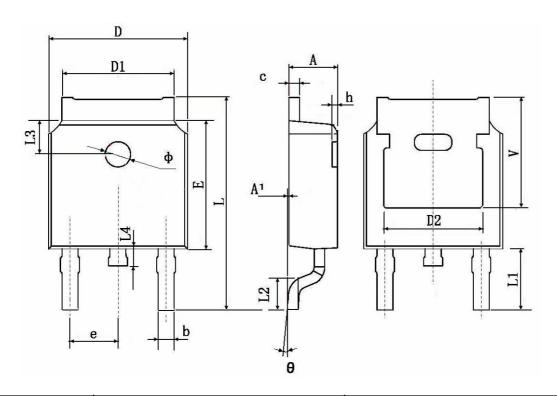


Figure 11. Normalized Maximum Transient Thermal Impedance



# TO-252-2L(DPAK) Package Information



| Symbol | Dimensions In Millimeters |            | Dimensions In Inches |       |
|--------|---------------------------|------------|----------------------|-------|
|        | Min.                      | Max.       | Min.                 | Max.  |
| Α      | 2.200                     | 2.400      | 0.087                | 0.094 |
| A1     | 0.000                     | 0.127      | 0.000                | 0.005 |
| b      | 0.660                     | 0.860      | 0.026                | 0.034 |
| С      | 0.460                     | 0.580      | 0.018                | 0.023 |
| D      | 6.500                     | 6.700      | 0.256                | 0.264 |
| D1     | 5.100                     | 5.460      | 0.201                | 0.215 |
| D2     | 0.483                     | 0.483 TYP. |                      | TYP.  |
| Е      | 6.000                     | 6.200      | 0.236                | 0.244 |
| е      | 2.186                     | 2.386      | 0.086                | 0.094 |
| L      | 9.800                     | 10.400     | 0.386                | 0.409 |
| L1     | 2.900 TYP.                |            | 0.114 TYP.           |       |
| L2     | 1.400                     | 1.700      | 0.055                | 0.067 |
| L3     | 1.600 TYP.                |            | 0.063 TYP.           |       |
| L4     | 0.600                     | 1.000      | 0.024                | 0.039 |
| Ф      | 1.100                     | 1.300      | 0.043                | 0.051 |
| θ      | 0°                        | 8°         | 0°                   | 8°    |
| h      | 0.000                     | 0.300      | 0.000                | 0.012 |
| V      | 5.350 TYP.                |            | 0.211 TYP.           |       |

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